MOSFETs Silicon N-channel MOS (U-MOSX-H)

TK6R9P08QM

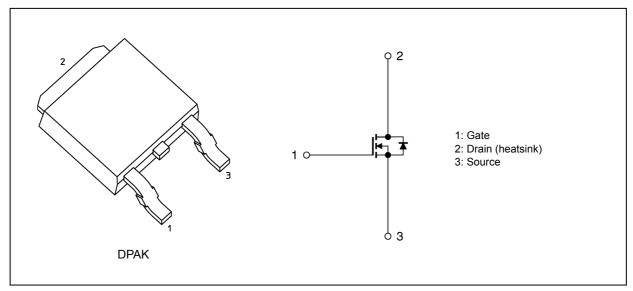
1. Applications

- High-Efficiency DC-DC Converters
- Switching Voltage Regulators
- Motor Drivers

2. Features

- (1) High-speed switching
- (2) Small gate charge: $Q_{SW} = 11.6 \text{ nC}$ (typ.)
- (3) Small output charge: $Q_{oss} = 46 \text{ nC}$ (typ.)
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 5.5 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (5) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 80 \ V)$
- (6) Enhancement mode: V_{th} = 2.5 to 3.5 V (V_{DS} = 10 V, I_D = 0.5 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25 \ ^{\circ}C$ unless otherwise specified)

Characteristi	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	80	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)	(T _c = 25 °C)	(Note 1)	Ι _D	62	A
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	Ι _D	83	
Drain current (pulsed)	(t = 100 μs)	(Note 1)	I _{DP}	210	
Power dissipation	(T _c = 25 °C)		PD	89	W
Single-pulse avalanche energy		(Note 3)	E _{AS}	24	mJ
Single-pulse avalanche current		(Note 3)	I _{AS}	62	A
Channel temperature			T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 175	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristics			Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)	R _{th(ch-c)}	1.67	°C/W

Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Limited 62 A by package capability

Note 3: V_{DD} = 64 V, T_{ch} = 25 °C (initial), L = 4.9 μ H, I_{AS} = 62 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V	_	—	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	80	—	—	V
Drain-source breakdown voltage (Note 4)	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	60	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.5 mA	2.5	_	3.5	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 6 V, I _D = 16 A		7.0	9.6	mΩ
		V _{GS} = 10 V, I _D = 31 A	_	5.5	6.9	

Note 4: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz	_	2700	_	pF
Reverse transfer capacitance	C _{rss}		_	45	—	
Output capacitance	C _{oss}		_	700	_	
Gate resistance	r _g	—	—	1.5	2.3	Ω
Switching time (rise time)	tr	See Fig. 6.2.1	_	45	—	ns
Switching time (turn-on time)	t _{on}		_	60	_	
Switching time (fall time)	t _f]	_	53	_	
Switching time (turn-off time)	t _{off}		_	89	_	

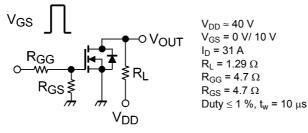


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus	Qg	$V_{DD}\approx 40$ V, V_{GS} = 10 V, I_{D} = 31 A	_	39	_	nC
gate-drain)		$V_{DD} \approx 40$ V, V_{GS} = 6 V, I_D = 16 A	_	24	_	
Gate-source charge 1	Q _{gs1}	$V_{DD} \approx 40$ V, V_{GS} = 10 V, I_D = 31 A	_	11.5	_	
Gate-drain charge	Q _{gd}		_	8.6	_	
Gate switch charge	Q _{SW}		_	11.6	_	
Output charge	Q _{oss}	V _{DS} = 40 V, V _{GS} = 0 V, f = 1 MHz	_	46	_	

6.4. Source-Drain Characteristics ($T_a = 25$ °C unless otherwise specified)

Characteristics Symbo		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (N	ote 5)	I _{DRP} (t = 100 μs)	_	_	_	210	A
Diode forward voltage		V _{DSF}	I _{DR} = 31 A, V _{GS} = 0 V	_	_	-1.2	V
Reverse recovery time		t _{rr}	I _{DR} = 15.5 A, V _{GS} = 0 V,	_	39	_	ns
Reverse recovery charge		Q _{rr}	-dI _{DR} /dt = 100 A/μs	_	35	_	nC

Note 5: Ensure that the channel temperature does not exceed 175 °C.

7. Marking

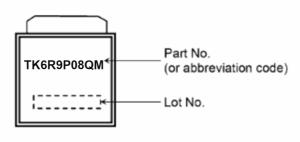
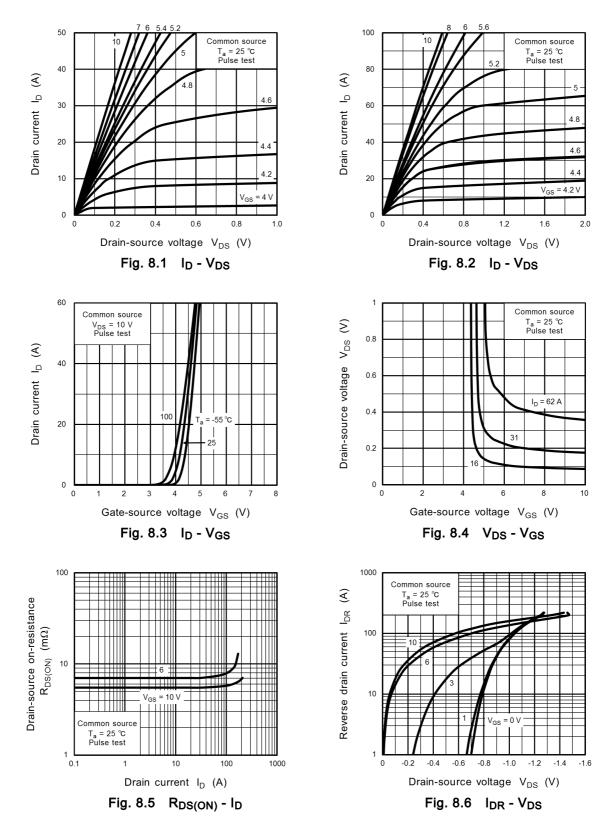
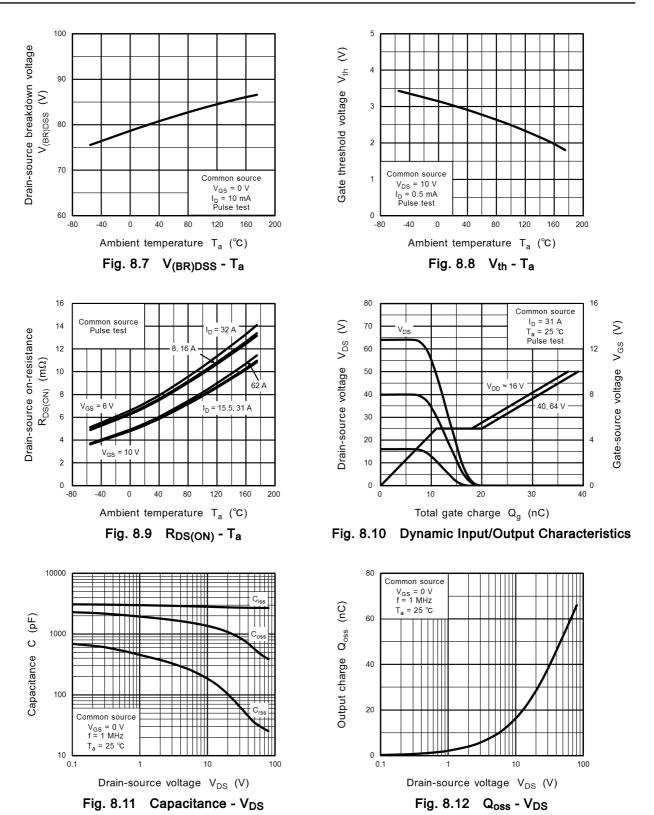
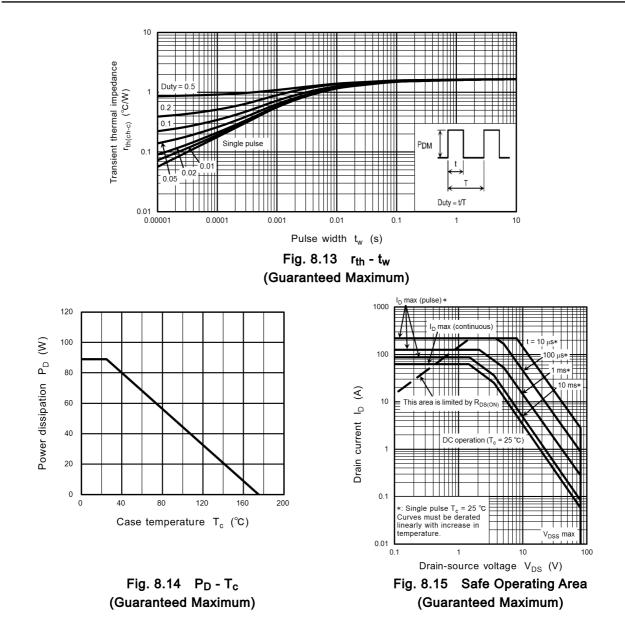


Fig. 7.1 Marking

8. Characteristics Curves (Note)





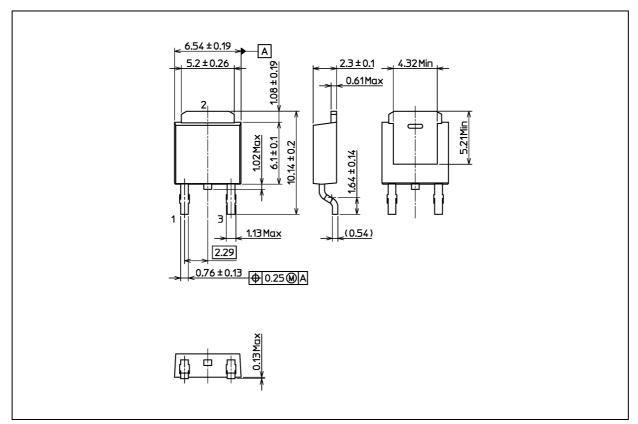


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

TK6R9P08QM

Package Dimensions

Unit: mm



Weight: 0.33 g (typ.)

Package Name(s)	
TOSHIBA: 2-7N1S	
Nickname: DPAK	

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